



Product Change Notification

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The information below reflects a change that is being implemented.

Notice Date: 09/05/2003

Product Category: PIC12xxx; PIC16xxx; PIC17xxx; PIC18xxx

Notification Subject: Change #440 - 64L TQFP At MTAI Assembly

Notification Body:

Description of Change:
To qualify 64Lead TQFP 10x10x1mm package at MTAI


Impacts to Data Sheet:
None

Reason for Change:
Increased manufacturing capacity for this package

Markings to Distinguish Revised From Unrevised Devices: (e.g.: Date Code, Device Marking, Ship Container Marking)
Date & Traceability Code

Devices

PIC12C671-ME
PIC12C672-ME
PIC12F675-ME
PIC16C01
PIC16C558A-ME
PIC16C622A-ME
PIC16C662-ME
PIC16C711-ME
PIC16C715-ME
PIC16C717-ME
PIC16C771-ME
PIC16C782-ME
PIC16C923
PIC16C924
PIC16C925
PIC16C926
PIC16CR84-ME
PIC16F628-ME
PIC16F648-ME
PIC16F676-ME

A photograph of a Microchip PIC18LF6680 microcontroller chip, showing its square package and various pins.

PIC16F819-ME
PIC16F84A-ME
PIC16F88-ME
PIC16LC924
PIC16LC925
PIC16LC926
PIC17C752
PIC17C756A
PIC17LC752
PIC17LC756A
PIC18C601
PIC18C658
PIC18F6520
PIC18F6520
PIC18F6620
PIC18F6621
PIC18F6680
PIC18LC601
PIC18LF6520
PIC18LF6520
PIC18LF6620
PIC18LF6621
PIC18LF6680